

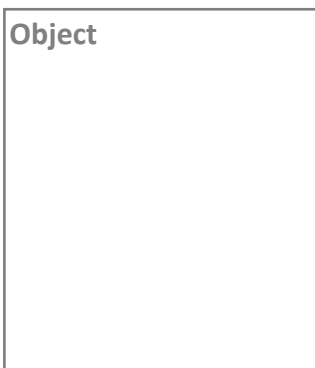
Features

- Fabricated by semiconductor lithography process
- Compatible with micro-assembly process
- Protection with passivation layer string environmental adaptability
- Precise overall dimensions
- Stable batch parameters

Typical Applications

- Microwave hybrid integrated components
- VCO
- Pin switch

Object



Image



Product list

Model Number	Turns	Inductance (nH)(typ.)	Rs@DC (Ohm)	Rs@GHz (Ohm)	Q@GHz	Resonant Frequency (GHz)	Chip Size (mm)
SAC6005A	3.5	5	1.0	3.7@4.0	26.5@4.0	16.5	0.75×0.75×0.2
SAC6007P5A	4.5	7.5	1.3	6.0@4.0	27.0@4.0	12.8	0.80×0.80×0.2
SAC6010A	5.5	10	1.6	8.0@4.0	26.0@4.0	11.3	0.80×0.80×0.2
SAC6015A	6.5	15	2.1	5.6@4.0	26.5@4.0	8.5	0.80×0.80×0.2
SAC6020A	7.5	20	2.6	7.5@2.0	28.5@2.0	7.0	0.80×0.80×0.2
SAC6050A	9.5	50	5.1	10.6@1.0	28.5@1.5	2.8	0.95×0.95×0.2
SAC6090A	12.5	90	8.0	26.3@1.0	26.5@1.0	1.8	1.10×1.10×0.2
SAC6200A	17.5	200	14.0	30.0@1.0	23.0@1.0	1.0	1.37×1.37×0.2